CRMGBU0205A

P-Channel -20V, 5.3mΩ Typ. Power MOSFET

Description

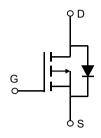
Features

• -20V, -55A

$$R_{DS(ON)}$$
 Typ = 5.3m Ω @ V_{GS} = -4.5 V

$$R_{DS(ON)}$$
 Typ = 6.9m Ω @ V_{GS} = -2.5 V

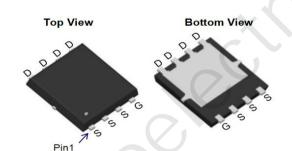
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

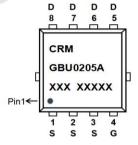


Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGBU0205A	CRMGBU0205A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		-20	V
V_{GS}	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	T _C = 25°C	-55	А
I _D		T _C = 100°C	-33	А
I _{DM}	Pulsed Drain Current (1)		-220	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		53	mJ
P_{D}	Power Dissipation	T _C = 25°C	36.7	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		3.4	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-20	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -20V, V_{GS} = 0V$	-	-	-1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.4	-0.65	-1	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = -4.5V, I_{D} = -15A$	-	5.3	6.9	mΩ
		$V_{GS} = -2.5V, I_{D} = -10A$	-	6.9	9	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		<u>-</u> (3460	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = -10V,$ f = 1MHz	X - \	545	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1141112		490	-	pF
Q_g	Total Gate Charge		<u> </u>	58	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } -4.5V$ $V_{DS} = -4.5V, I_{D} = -15A$	-	7	-	nC
Q_gd	Gate Drain("Miller") Charge	V _{DS} = 4.0 V, I _D = 10/1	-	15	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.()	-	13	-	ns
t _r	Turn-On Rise Time	$V_{GS} = -10V, V_{DD} = -10V$	-	108	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_{D} = -15A, R_{GEN} = 2.7 Ω	-	160	-	ns
t_f	Turn-Off Fall Time		-	155	-	ns
Drain-So	urce Diode Characteristics and N	Max Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	-55	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-220	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = -15A	-	-	-1.2	V
trr	Body Diode Reverse Recovery Time	I - 454 di/dt - 4004/:	-	18	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = -15A$, di/dt = 100A/us	-	7.7	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =-10V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =-14.5A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

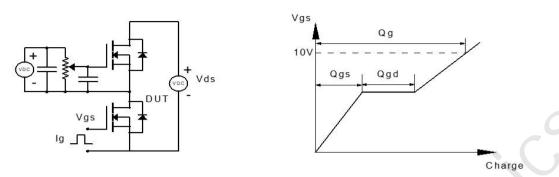


Figure 1: Gate Charge Test Circuit & Waveform

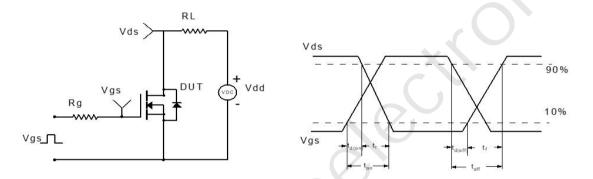


Figure 2: Resistive Switching Test Circuit & Waveform

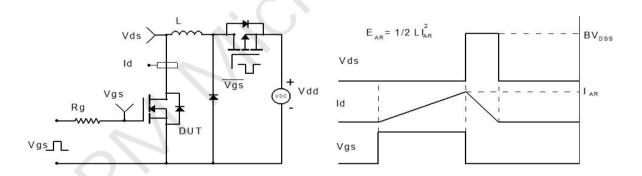


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

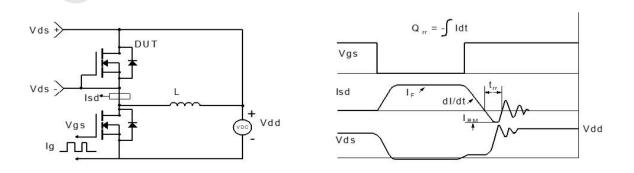
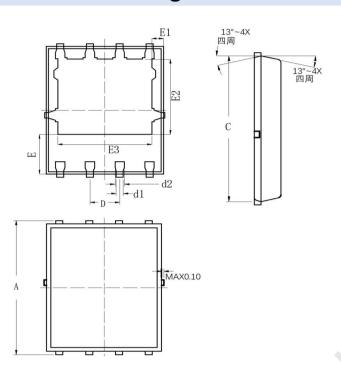


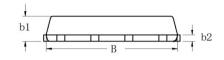
Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(PDFN5x6-8L)





	COMMON DIM	TENSION (MM)	5	
PKG	PDFN 5×6-8L			
SYMBOL	MIN	TYP	MAX	
Α	6.000	6.100	6.200	
В	4.875	4.900	4.925	
b1	0.975	1.000	1.025	
b2	0.246	0.254	0.262	
С	5.775	5.800	5.825	
D	1.245	1.270	1.295	
d1	0.275	0.300	0.325	
d2	0.375	0.400	0.425	
E	1.725	1.775	1.825	
E1	0.395	0.445	0.495	
E2	3.425	3.475	3.525	
E3	3.960	4.010	4.060	

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